

RX Family

R01AN2238EJ0140 Rev.1.40 Jun 30, 2022

Sample Program using USB Peripheral Communication Device Class Driver (PCDC) to communicate via USB with USB Host Firmware Integration Technology

Introduction

This document describes the following sample firmware: USB Peripheral Communication Devices Class Driver using Firmware Integration Technology. The sample firmware is referred to below as the PCDC.

When developing an actual software, be sure to use the "USB Basic Host and Peripheral Driver Firmware Integration Technology Application Note" (Document number: R01AN2025) together with the user's manual for each MCU (Hardware). In addition, also refer to the "USB Peripheral Communication Device Class Driver (PCDC) Firmware Integration Technology Application Note" (Document number: R01AN2030), if necessary. "USB Basic Host and Peripheral Driver Firmware Integration Technology Application Note" (Document number: R01AN2025) is located in the "reference documents" folder within the package.

Target Device

RX65N/RX651 Group

RX64M Group

RX71M Group

RX66T Group

RX72T Group

RX72M Group

RX66N Group

RX72N Group

RX671 Group

The operation of this program has been confirmed using the Renesas Starter Kits (RSK).

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1. Introduction

1.1 Functions

The PCDC conforms to the Abstract Control Model of the USB communication device class (CDC) specification and implements communication with the USB host PC.

The PCDC provides the following functionalities:

- · Implements USB-serial conversion functionality and USB loopback communication functionality (echo mode).
- It is recognized as a communication class (virtual COM) when connected to a USB host.
- Supports communication by designating a virtual COM port in the terminal software.

1.2 FIT Module Configuration

The PCDC comprises the following FIT modules and a sample application:

Table 1-1 FIT Module Configuration

FIT Module	Folder Name
RX Family Board Support Package Module	
Firmware Integration Technology	
RX Family USB Basic Host and Peripheral Driver	
Firmware Integration Technology	
RX Family USB Peripheral Communications Devices Class Driver(PCDC)	r usb pcdc
Firmware Integration Technology	1_usb_pcuc
RX Family DTC Module Using Firmware Integration Technology	r_dtc_rx
RX Family DMA Controller DMACA Control Module	r dmaaa m
Firmware Integration Technology	r_dmaca_rx
RX Family BYTEQ Module Using Firmware Integration Technology	r_byteq
RX Family SCI Multi-Mode Module Using Firmware Integration Technology	r_sci_rx

Refer to the related documentation for details of each FIT module. Note that the latest versions of the FIT modules used by the sample firmware are available for download from the following website:

Renesas Electronics website: http://www.renesas.com/

1.3 Note

This driver is not guaranteed to provide USB communication operation. The customer should verify operation when utilizing it in a system and confirm the ability to connect to a variety of different types of devices.

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1.4 **Operating Confirmation Environment**

The following is the operating confirmation environment of this program.

Table 1-2 Operating Confirmation Environment

Item	Contents		
C compiler	Renesas Electronics C/C++ compiler for RX Family V.3.03.00		
	Compile Option : -lang = c99		
Real-Time OS	FreeRTOS V.10.0.0		
	RI600V4		
	Azure RTOS (USBX) 6.1.11		
Endian	Little Endian, Big Endian		
USB Driver Revision Number	Rev.1.40		
Using Board	Renesas Starter Kits for RX64M		
	Renesas Starter Kits for RX71M		
	Renesas Starter Kits for RX65N, Renesas Starter Kits for RX65N-2MB		
	Renesas Starter Kits for RX72T		
	Renesas Starter Kits for RX72M		
	Renesas Starter Kits for RX72N		
	Renesas Starter Kits for RX671		
Host Environment	The operation of this USB Driver module connected to the following OSes has been confirmed.		
	1. Windows® 8.1		
	2. Windows® 10		

1.5 **Terms and Abbreviations**

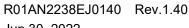
APL : Application program

CDC **Communications Devices Class**

H/W Renesas USB device Non-OS USB Driver for OS-less

Peripheral Control Driver for USB-BASIC-FW PCD Peripheral Communications Devices Class **PCDC**

RTOS USB Driver for the real-time OS Serial Communication Interface SCI USB-BASIC-FW : USB Basic Host and Peripheral Driver



2. Software Configuration

2.1 Module Configuration

The PCDC has a USB-serial converter mode and a USB loopback mode (echo mode). In USB-serial converter mode it uses the serial communication interface (SCI). LCD display and low-power control processing are implemented as a sample application.

Figure 2-1 shows the module configuration of the PCDC, and Table 2-1 lists the functions of the modules.

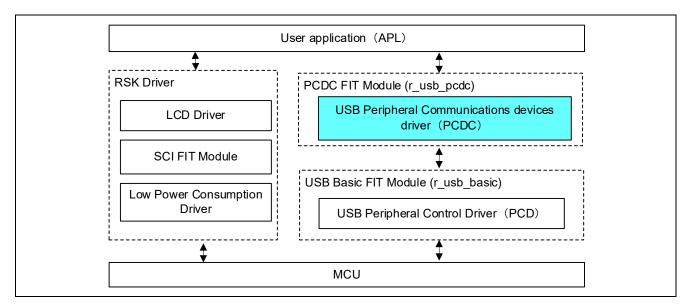


Figure 2-1 Module Configuration

Table 2-1 Functions of Modules

Module Name	Function		
APL	Sample application program		
RSK driver	Sample application for using the peripheral functions of the RSK.		
PCDC (r_usb_pcdc)	CDC class driver		
	Interprets requests from the USB host.		
	Provides data transfer services between the APL and the USB host, via the PCD.		
PCD (r_usb_basic)	USB Basic Driver		

3. Setup

3.1 Hardware

3.1.1 Example Operating Environment

Figure 3-1 and Figure 3-2 show an example operating environment for the PCDC. Refer to the associated instruction manuals for details on setting up the evaluation board and using the emulator, etc.

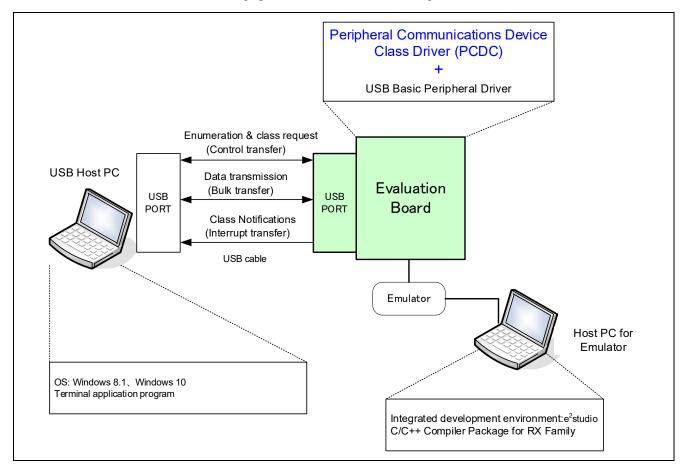


Figure 3-1 Example Operating Environment (Echo Mode)

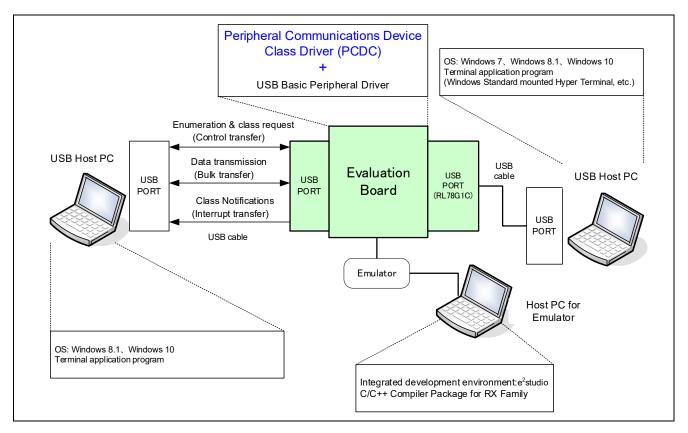


Figure 3-2 Example Operating Environment (USB-Serial Converter Mode)

Table 3-1 shows the evaluation board on which operation has been confirmed.

Table 3-1 Evaluation Board on which PCDC Operation Has Been Verified

MCU	Evaluation Board
RX65N	RSK+RX65N, RSK+RX65N
RX64M	RSK+RX64M
RX71M	RSK+RX71M
RX72T	RSKRX72T
RX72M	RSK+RX72M
RX72N	RSK+RX72N
RX671	RSK+RX671

RSK Setting 3.1.1

It is necessary to set RSK to operate in the peripheral mode. Please refer to the following.

Table 3-2 **RSK Setting**

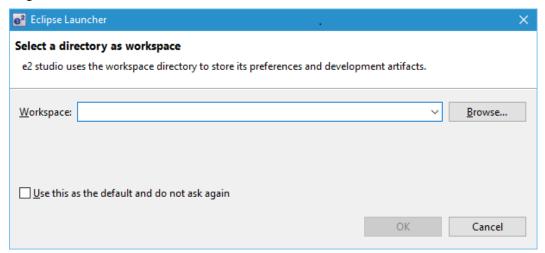
RSK	Jumper Setting
RSK+RX65N	J8: Shorted Pin2-3
RSK+RX65N_2MB	J7: Shorted Pin2-3
	J16: Shorted Pin1-2
RSK+RX64M (USB0)	J2: Shorted Pin2-3
	J6: Shorted Pin1-2
RSK+RX64M (USBH)	J7: Shorted Pin2-3
	J9: Shorted Pin1-2
RSK+RX71M (USB0)	J1: Shorted Pin2-3
	J3: Shorted Pin1-2
RSK+RX71M (USBA)	J4: Shorted Pin2-3
	J7: Shorted Pin1-2
RSKRX72T	J13: Shorted Pin2-3
RSK+RX72M	J8: Shorted Pin1-2
	J10: Shorted Pin1-2
RSK+RX72N	J7: Shorted Pin1-2
	J8: Shorted Pin1-2
RSK+RX671	J8: Shorted Pin1-2
	J13: Shorted Pin1-2

Note:

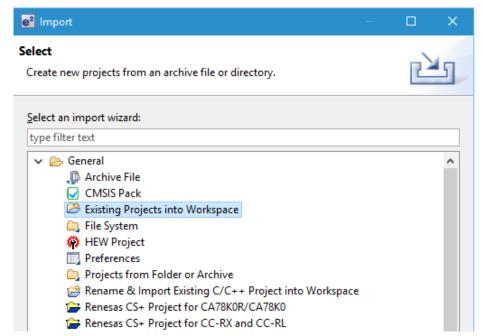
For the detail of RSK setting, refer to the user's manual of RSK.

3.2 Software

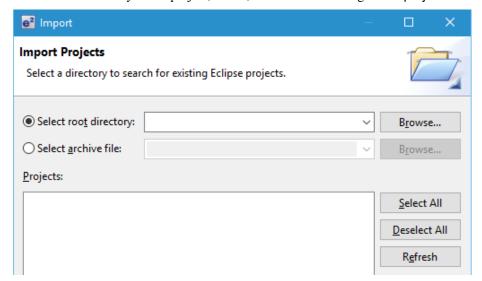
- 1) Setup e² studio
 - a) Start e² studio
 - b) If you start up e² studio at first, the following dialog is displayed. Specify the folder to store the project in this dialog.



- 2) Import the project to the workspace
 - a) Select [File] > [Import]
 - b) Select [General] => [Existing Projects into Workspace]



c) Select the root directory of the project, that is, the folder containing the ".cproject" file.



- 3) Click "Finish".
 - You have now imported the project into the workspace. Note that you can import other projects into the same workspace.
- 4) Generate the binary target program by clicking the "Build" button.
- 5) Connect the target board to the debug tool and download the executable. The target is run by clicking the "Run" button.

4. Sample Application

4.1 Application Specifications

The main functions of the APL are as follows:

1) Echo mode (Loopback mode) (Note1)

Transmits data received from the USB host back to the USB host.

2) USB-serial converter mode (Note1) (Note2) (Note3) (Note4)

Transmits data received from the USB host back to a COM port and data received from the COM port to the USB host. Note that if a COM port error (parity error, framing error, or overrun error) occurs, the APL sends a "SerialState" class notification to the USB host.

3) Low-power functionality

This functionality transitions the MCU to low-power mode according to the status of the USB.

- a. The APL transitions the MCU to sleep mode when the USB is suspended.
- b. When the USB is detached (disconnected), the APL transitions the MCU to software standby mode.
- (Note1) The selection of Echo mode or USB-serial converter mode is made by setting the "OPERATION_MODE" macro definition in the file "r_usb_pcdc_apl_config.h."
- (Note2) The COM port is connected to RL78G1C on the RSK, so G1CUSB0 is used for USB-USB communication.
- (Note3) The following jumper settings must be made on the RSK board to use USB-serial converter mode:

RSK+RX64M / RSK+RX71M			RSK+RX65N		
Port	Signal	Jumper setting	Port	Signal	Jumper setting
P90	A-TXD7	J16.2-3	P50	TXD2	-
P92	A-RXD7	J19.2-3	P52	RXD2	1
RSKRX72T			RSK+RX65N_2MB		
Port	Signal	Jumper setting	Port	Signal	Jumper setting
PB5	TXD5		PJ2	TXD8	1
PB6	RXD5		PJ1	RXD8	-
RSK+RX72M			RSK+RX72N		
	RSK+RX72	2M		RSK+RX7	72N
Port	RSK+RX72 Signal	Jumper setting	Port	RSK+RX7 Signal	72N Jumper setting
Port P00			Port PL2		
	Signal			Signal	
P00	Signal TXD6	Jumper setting	PL2	Signal TXD9	
P00	Signal TXD6 RXD6	Jumper setting	PL2	Signal TXD9	
P00 P01	Signal TXD6 RXD6 RSK+RX6	Jumper setting 71	PL2	Signal TXD9	

Table 4-1 USB-Serial Converter Mode Jumper Settings

(Note4) To select USB-serial converter mode, the following FIT is required.

- a) RX Family Serial Communication Interface Firmware Integration Technology
- b) RX Family BYTEQ Module Firmware Integration Technology

4.2 Application Processing (for Non-OS)

The APL comprises two parts: initial settings and main loop. An overview of the processing in these two parts is provided below.

4.2.1 Initial Setting

Initial settings consist of MCU pin settings, USB driver settings, and initial settings to the USB controller.

4.2.2 Main Loop (Echo mode)

In Echo mode, loop-back processing in which data sent by the USB host is received and then transmitted unmodified back to the USB host takes place as part of the main routine. An overview of the processing performed by the loop is shown below.

- 1. When the R_USB_GetEvent function is called after enumeration with the USB host completes, USB_STS_CONFIGURED is set as the return value. When the APL confirms USB_STS_CONFIGURED, it calls the R_USB_Read function to make a data receive request for data sent by the USB host.
- 2. When enumeration with the USB host completes, the USB host sends an CDC class request to the CDC device. After it receives the CDC class request, the CDC device calls the *R_USB_GetEvent* function and the return value is set to *USB_STS_REQUST*. When the APL confirms *USB_STS_REQUEST*, it analyzes the received class request and performs processing corresponding to it.
- 3. When the R_USB_GetEvent function is called after reception of data from the USB host has completed, USB_STS_READ_COMPLETE is set as the return value. When the APL confirms USB_STS_READ_COMPLETE, it calls the R_USB_Write function to make a data transmit request to transmit the received data to the USB host.
- 4. When the R_USB_GetEvent function is called after transmission of data to the USB host completes, USB_STS_WRITE_COMPLETE is set as the return value. When the APL confirms USB_STS_WRITE_COMPLETE, it calls the R_USB_Read function to make a data receive request for data sent by the USB host.
- 5. The processing in steps 3 and 4, above, is repeated.
- 6. When it confirms reception of a suspend signal from the USB host or DETACH, the APL performs processing to transition the CDC device (RSK) to low-power mode. For information on low-power mode, refer to 4.4, MCU Low power consumption processing. Note that confirmation of reception of a suspend signal or DETACH is performed by referencing the return value (*USB_STS_SUSPEND* or *USB_STS_DETACH*) of the *R_USB_GetEvent* function.



An overview of the processing performed by the APL is shown below:

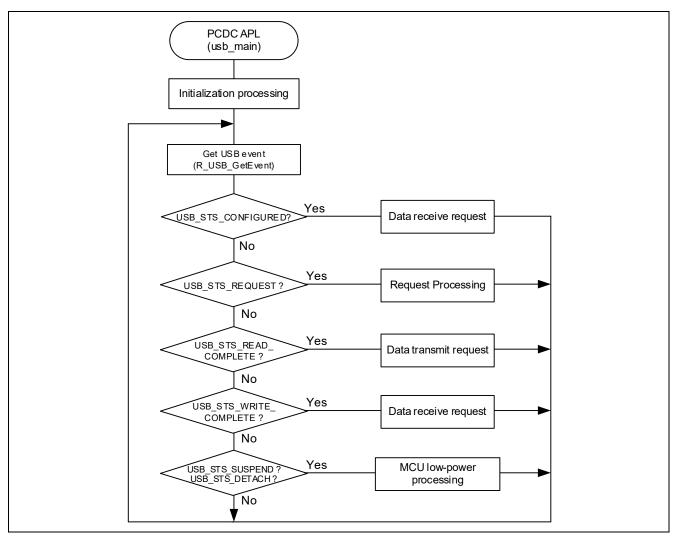


Figure 4-1 Main Loop processing (Echo mode)

4.2.3 Main Loop (USB-serial converter mode)

The processing performed in USB serial convert-back mode is described below.

- Reception of data from the USB host, and transmission of the received data to the COM port.
- b. Transmission to the USB host of data received from the COM port.

An overview of the processing of the main loop is presented below.

- 1. When the R USB GetEvent function is called after enumeration with the USB host completes. USB STS CONFIGURED is set as the return value. When the APL confirms USB STS CONFIGURED, it calls the R USB Read function to make a data receive request for Bulk data sent by the USB host.
- 2. When enumeration with the USB host completes, the USB host sends an CDC class request to the CDC device. After it receives the CDC class request, the CDC device calls the R USB GetEvent function and the return value is set to USB STS REQUST. When the APL confirms USB STS_REQUEST, it analyzes the received class request and performs processing corresponding to it.
- 3. When the R USB GetEvent function is called after processing of the class request mentioned in 2, above, completes, the return value is set to USB STS REQUST COMPLETE. The APL performs processing to make request information settings, etc.
- 4. When the R USB GetEvent function is called after reception of Bulk data by the USB host has completed, USB STS READ COMPLETE is set as the return value. When the APL confirms USB STS READ COMPLETE, it sets the reception data size to a gloval variable.
- 5. When the R USB GetEvent function is called after sending of USB data (refer to step 6, below) to the USB host has completed, USB STS WRITE COMPLETE is set as the return value. When the APL confirms USB STS WRITE COMPLETE, it references member type in the usb ctrl t structure to identify the device class on which data transmission has completed. It then sets the completion flag corresponding to the device class on which data transmission has completed. This flag is referenced in step 6, below.
- 6. The following transmission processing is performed after completing the above processing. Note that before the transmission processing described below, the flags set in steps 4 and 5 above are referenced to determine if transmission is possible.
 - (1).SCI transmission processing to send bulk data received from the USB host to the COM port and the data reception processing from USB Host.
 - (2).If a SCI error (parity error, framing error, overrun error, etc.) has been detected, class notification (serial state) transmit request processing to notify the USB host
 - **(3)**. Data transmit request processing to send the data received from the COM port to the USB host
- 7. If reception of a suspend signal from the USB host or DETACH is confirmed while the above processings are repeating, the APL performs processing to transition the CDC device (RSK) to low-power mode. For information on low-power mode, refer to 4.4, MCU Low power consumption processing. Note that confirmation of reception of a suspend signal or DETACH is performed by referencing the return value (USB STS SUSPEND or USB STS DETACH) of the R USB GetEvent function.

An overview of the processing performed by the APL is shown below:

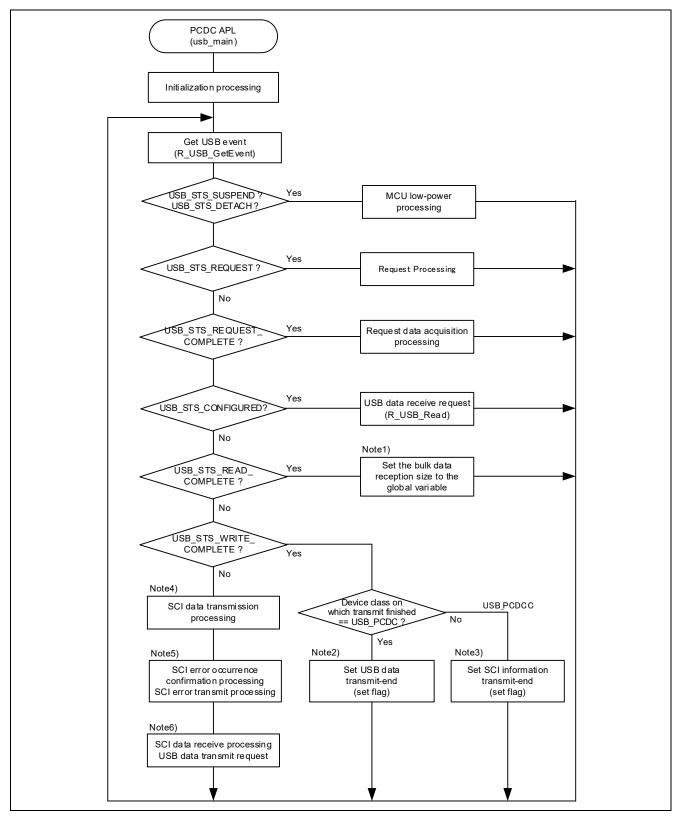


Figure 4-2 Main Loop processing (USB-serial converter mode mode)

- (Note1) The reception data size is set to a global variable. This variable is referred in (Note4).
- (Note2) Sets the USB data transmit-end flag. This flag is referenced in the processing described in (Note6).

- (Note3) Sets the SCI information (serial state) transmit-end flag. This flag is referenced in the processing described in (Note5).
- (Note4) References the global variable in (Note1) and performs SCI data transmit processing. If SCI data transmission completes normally, the SCI transmit request flag is cleared. If SCI data transmission fails, the SCI transmit request flag it not cleared so that SCI data transmit processing will be retried.
- (Note5) Performs processing to check the SCI status for the occurrence of an error. If an error has occurred, the *R_USB_Write* function is used to send error information to the USB host.
- (Note6) References the flag mentioned in (Note2) to confirm whether USB transmission is possible. If transmission is possible, the USB_Write function is used to send the received SCI data to the USB host. Note that confirmation of reception of data from the COM port is not performed until transmission of data to the USB host completes.

4.3 Application Processing (for RTOS)

The APL comprises two parts: initial settings and main loop. An overview of the processing in these two parts is provided below.

4.3.1 Initial Setting

Initial settings consist of MCU pin settings, USB driver settings, and initial settings to the USB controller.

4.3.2 Main Loop (Echo mode)

In Echo mode, loop-back processing in which data sent by the USB host is received and then transmitted unmodified back to the USB host takes place as part of the main routine. An overview of the processing performed by the loop is shown below. The following is the process for FreeRTOS or uITRON.

- 1. When a USB-related event has completed, the USB driver calls the callback function (*usb_apl_callback*). In the callback function (*usb_apl_callback*), the application task (APL) is notified of the USB completion event using the real-time OS functionality.
- 2. In APL, information regarding the USB completion event was notified from the callback function is retrieved using the real-time OS functionality.
- 3. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_CONFIGURED*, APL performs a data reception request to receive data transmitted from the USB Host by calling the *R_USB_Read* function.
- 4. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB STS REQUEST*, APL performs processing in response to the received request.
- 5. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_READ_COMPLETE*, APL performs a data transmission request to send USB Host the reception data by calling the *R_USB_Write* function.
- 6. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_WRITE_COMPLETE*, APL performs a data reception request to receive the data sent from USB Host by calling the *R_USB_Read* function.
- 7. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_SUSPEND* or *USB_STS_DETACH*, APL performs processing to transition the CDC device (RSK) to low-power mode. For information on low-power mode, refer to 4.4, MCU Low power consumption processing.



An overview of the processing performed by the APL is shown below:

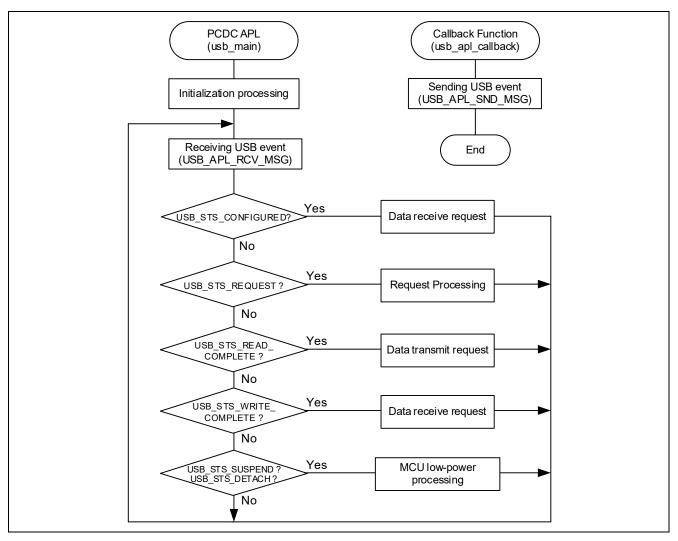


Figure 4-3 Main Loop processing (Echo mode)

4.3.3 Main Loop (USB-serial converter mode)

The processing performed in USB serial convert-back mode is described below. This mode is not supported in Azure

- а Reception of data from the USB host, and transmission of the received data to the COM port.
- Transmission to the USB host of data received from the COM port. b.

An overview of the processing of the main loop is presented below.

- When a USB-related event has completed, the USB driver calls the callback function (usb apl callback). In the callback function (usb apl callback), the application task (APL) is notified of the USB completion event using the real-time OS functionality.
- In APL, information regarding the USB completion event was notified from the callback function is retrieved using the real-time OS functionality.
- If the USB completion event (the *event* member of the *usb* ctrl t structure) retrieved in step 2 above is USB STS CONFIGURED, APL performs a data reception request to receive data transmitted from the USB Host by calling the R USB Read function.
- If the USB completion event (the event member of the usb ctrl t structure) retrieved in step 2 above is USB STS REQUEST, APL performs processing in response to the received request.
- If the USB completion event (the event member of the usb ctrl t structure) retrieved in step 2 above is USB STS REQUEST COMPLETE, APL performs processing to make request information settings, etc.
- If the USB completion event (the event member of the usb ctrl t structure) retrieved in step 2 above is USB STS READ COMPLETE, APL sets the reception data size to a gloval variable.
- If the USB completion event (the event member of the usb ctrl t structure) retrieved in step 2 above is USB STS WRITE COMPLETE, APL references member type in the usb ctrl t structure to identify the device class on which data transmission has completed. It then sets the completion flag corresponding to the device class on which data transmission has completed. This flag is referenced in step 9, below.
- If the USB completion event (the event member of the usb ctrl t structure) retrieved in step 2 above is USB STS SUSPEND or USB STS DETACH, APL performs processing to transition the CDC device (RSK) to low-power mode. For information on low-power mode, refer to 4.4, MCU Low power consumption processing.
- The following transmission processing is performed after completing the above processing. Note that before the transmission processing described below, the flags set in steps 5 and 7 above are referenced to determine if transmission is possible.
 - (1).SCI transmission processing to send bulk data received from the USB host to the COM port and the data reception processing from USB Host.
 - If a SCI error (parity error, framing error, overrun error, etc.) has been detected, class notification (serial **(2)**. state) transmit request processing to notify the USB host
 - (3). Data transmit request processing to send the data received from the COM port to the USB host

An overview of the processing performed by the APL is shown below:

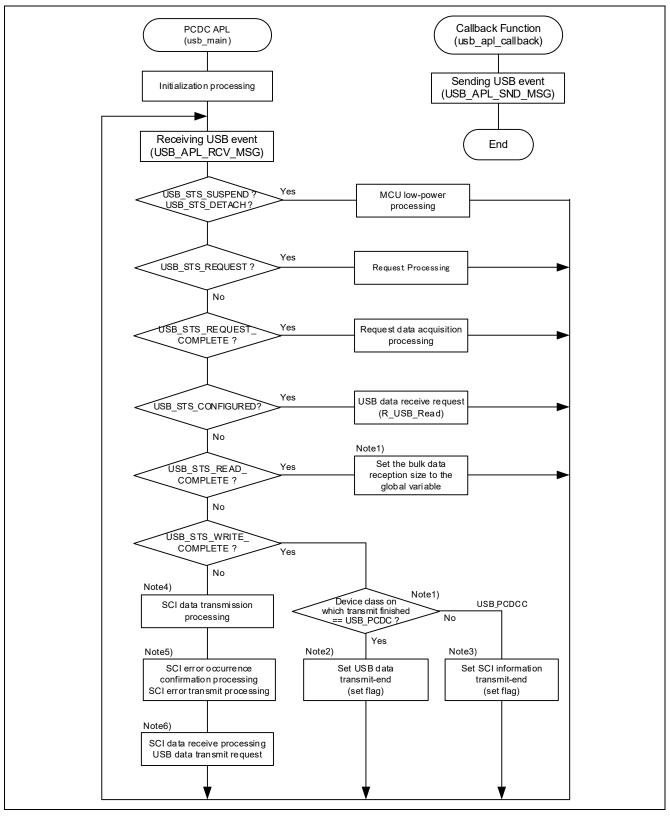


Figure 4-4 Main Loop processing (USB-serial converter mode mode)

- (Note1) The reception data size is set to a global variable. This variable is referred in (Note4).
- (Note2) Sets the USB data transmit-end flag. This flag is referenced in the processing described in (Note6).

- (Note3) Sets the SCI information (serial state) transmit-end flag. This flag is referenced in the processing described in (Note5).
- (Note4) References the global variable in (Note1) and performs SCI data transmit processing. If SCI data transmission completes normally, the SCI transmit request flag is cleared. If SCI data transmission fails, the SCI transmit request flag it not cleared so that SCI data transmit processing will be retried.
- (Note5) Performs processing to check the SCI status for the occurrence of an error. If an error has occurred, the *R_USB_Write* function is used to send error information to the USB host.
- (Note6) References the flag mentioned in (Note2) to confirm whether USB transmission is possible. If transmission is possible, the USB_Write function is used to send the received SCI data to the USB host. Note that confirmation of reception of data from the COM port is not performed until transmission of data to the USB host completes.

4.4 MCU Low power consumption processing

MCU low-power processing occurs when the conditions in Table 4-2 or Table 4-3 are met, causing a transition to low-power mode. To enable this processing, specify *USB_APL_ENABLE* to *USB_SUPPORT_LPW* definition in the *r usb pcdc apl config.h file*.

1. Non-OS

Transition Condition

VBUS

USB State

OFF

ON

Suspend Configured

ON

Other than Suspend Configured

Normal mode (program running)

Table 4-2 Conditions for Transition to Low-Power Mode

- (1). When the CDC device (RSK) detaches from the USB host (VBUS OFF), the APL performs processing to transition the MCU to software standby mode. Recovery from software standby mode occurs when the CDC device (RSK) attaches to the USB host.
- (2). When a suspend signal sent by the USB host is received while the CDC device (RSK) is connected to the USB host, the APL performs processing to transition the MCU to sleep mode. Note that recovery from sleep mode occurs when a resume signal is received from the USB host.

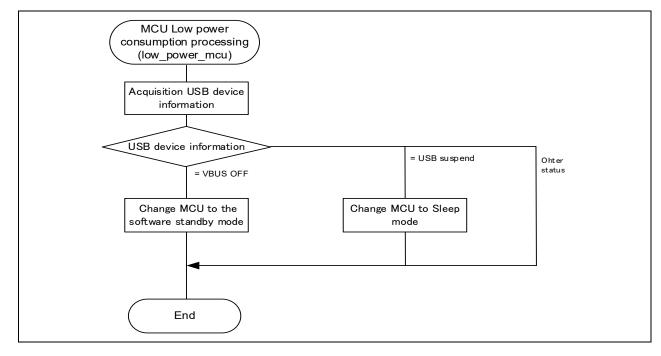


Figure 4-5 Flowchart of MCU Low Power Consumption Processing

2. RTOS (FreeRTOS only)

Table 4-3 Conditions for Transition to Low-Power Mode

Transition Co	ndition	Transition Status
VBUS	USB State	
OFF	_	Software standby mode
ON Suspend Configured		Software standby mode
ON Other than Suspend Configured		Normal mode (program running)

- (1). When the CDC device (RSK) detaches from the USB host (VBUS OFF), the APL performs processing to transition the MCU to software standby mode. Recovery from software standby mode occurs when the CDC device (RSK) attaches to the USB host.
- (2). When a suspend signal sent by the USB host is received while the CDC device (RSK) is connected to the USB host, the APL performs processing to transition the MCU to software standby mode. Note that recovery from softwre standby mode occurs when a resume signal is received from the USB host.

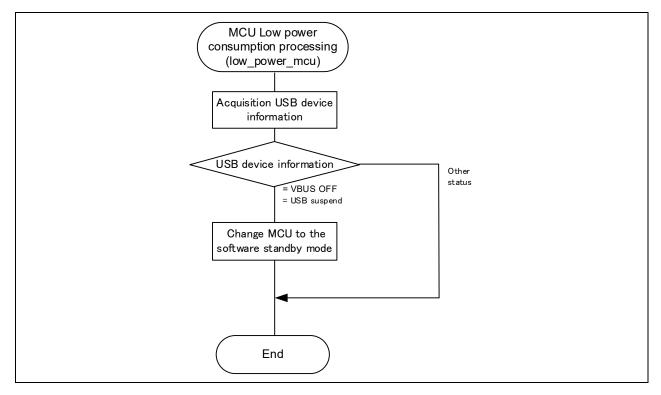


Figure 4-6 Flowchart of MCU Low Power Consumption Processing

4.5 Configuration File for the application program (r_usb_pcdc_apl_config.h)

Make settings for the definitions listed below.

USE_USBIP Definition

Specify the module number of the USB module you are using. Specify one of the following settings for the USE USBIP definition.

USE USBIP0 // Specify USB IP0. #define USE USBIP #define USE USBIP USE USBIP1 // Specify USB IP1.

USB SUPPORT SPEED Definition

Specify the USB operation speed (Hi-speed or Full-speed) which CDC device (RSK) supports.

USB SUPPORT SPEED #define HI SPEED // Hi-Speed setting #define USB_SUPPORT_SPEED FULL_SPEED // Full-Speed setting

[Note]

You can specify HI SPEED when using RX71M. Specify FULL SPEED when using the MCU other than RX71M.

OPERATION MODE Definition

Specify one of the following settings for the *OPERATION MODE* definition.

#define OPERATION MODE USB ECHO // Echo mode #define OPERATION_MODE USB_UART // USB-serial conversion mode

[Note]

Be sure to specify USB CFG ENABLE to USB CFG CLASS REQUEST definition in the r usb basic config.h

Low-Power Function Definition

Specify whether or not the low-power function will be used. If the low-power function will be used, speify USB APL ENABLE to USB SUPPORT LPW definition.

// No use the low-power function USE SUPPORT LPW USB APL DISABLE #define #define USB SUPPORT LPW USB APL ENABLE // Use the low-power function

USB SUPPORT RTOS Definition

Please specify USB APL ENABLE to USB SUPPORT RTOS definition when using the real-time OS.

#define **USB SUPPORT RTOS** USB APL DISABLE // No use the real-time OS #define **USB SUPPORT RTOS** USB APL ENABLE // Use the real-time OS

Note 6.

The above configuration settings apply to the application program. USB driver configuration settings (r usb basci config.h) are required in addition to the above settings. For information on USB driver configuration settings, refer to the application note USB Basic Host and Peripheral Driver Firmware Integration Technology (Document number. R01AN2025EJ).

4.6 **Descriptor**

The PCDC's descriptor information is contained in r usb pcdc descriptor.c. Also, please be sure to use your vendor

5. CDC Driver Installation

If USB Host is PC, CDC driver must be installed in the PC. When you connect RSK which this PCDC sample program is written in to your PC, the wizard shown in Figure 5-1 will appear on your screen and prompt the CDC driver installation

- (1). Select **Update Driver Software** from the device manager.
- (2). Select "Browse my computer for driver software".

Note:

- (1). It is not necessary the following installation work for CDC driver when using Window® 10.
- (2). The catalog file with the digital signature is required when using Windows® 8.1. The customer needs to create this catalog file.

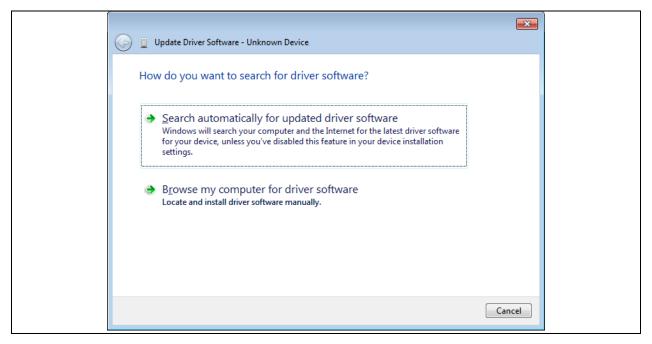


Figure 5-1 New Hardware Search Wizard

(3). Select "Browse for driver software on your computer"

Click Browse, specify the folder in which the CDC_Demo.inf is stored, then click "Next"

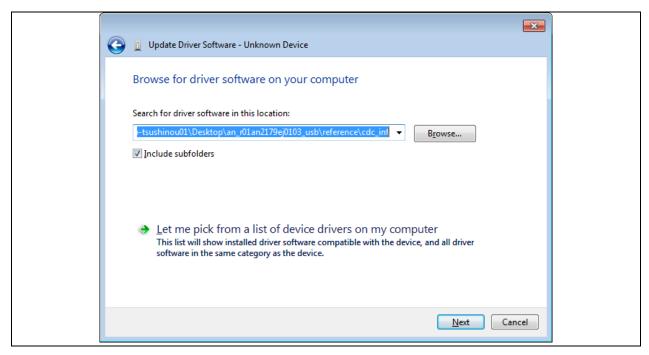


Figure 5-2 Select Driver Location

Note:

The CDC Demo.inf file is stored in "r usb pcdc\u00e4utilities" folder in the package.

(4). If the following installation confirmation screen appears, click "Browse for driver software on your computer"

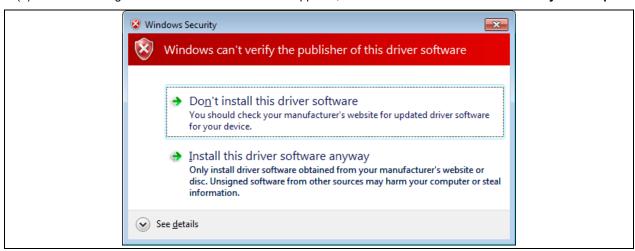


Figure 5-3 Installation Confirmation Screen

When the following window appears, the CDC driver has been successfully installed. Click "Close."

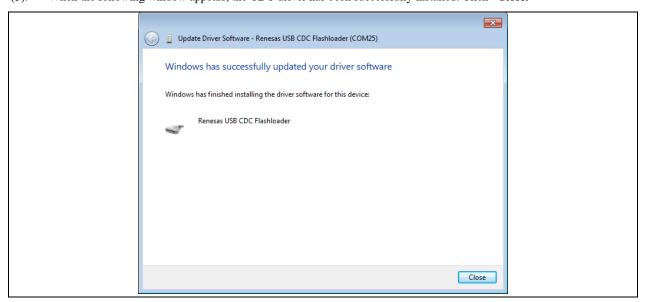


Figure 5-4 Installation Complete

6. Class Driver Overview

Class Request (Request from Host to Device) 6.1

Table 6-1 lists the class requests supported by the PCDC.

Table 6-1 Supported CDC Class Requests

Request	Coce	Description
SetLineCoding	0x21	Sets transmission line coding (transmission speed, data length, parity bit, stop bit length)
GetLineCoding	0x22	Notify transmission line coding state.
SetControlLineState	0x23	Sets control signals RTS and DTR for transmission line.

6.2 **Data Format**

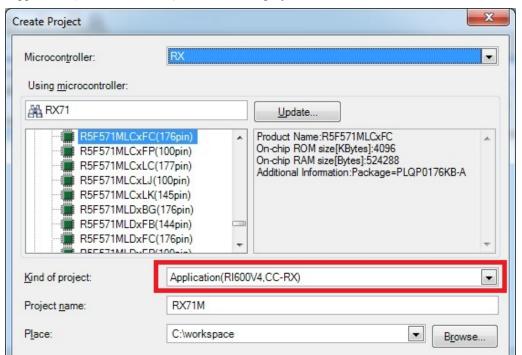
The CDC data class has no specified format. Data may be transferred in any format.

7. Using RI600V4 project with CS+

The RI600V4 project in the package does not support CS+. The user needs to create a project for CS+ according to the following procedure when using RI600V4 project on CS+.

7.1 New Project Creation

Select "Application(RI600V4, CC-RX) for the Kind of project.



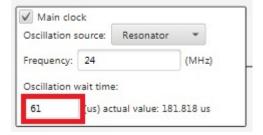
7.2 Launch Smart Configurator

1. Clock Setting (Select "Clocks" tab)

(1). Set the related clock so that "48MHz" is set to UCLK (USB clock).



(2). Set "61" to the oscillation wait time for the main clock.



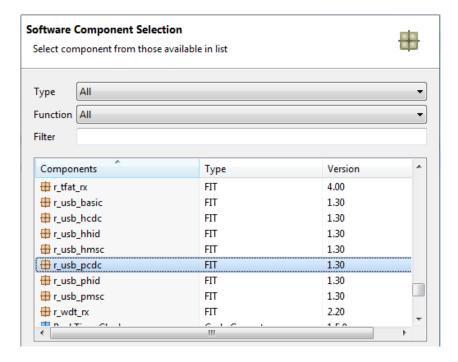
2. Component Setting (Select "Components" tab)

(1). Import the USB FIT module

Select the r_usb_pcdc module and press the "Finish" button. The r_usb_basic module is imported at the same time.

Note:

Select the r dtc rx/r dmaca rx module when using the DTC/DMA.

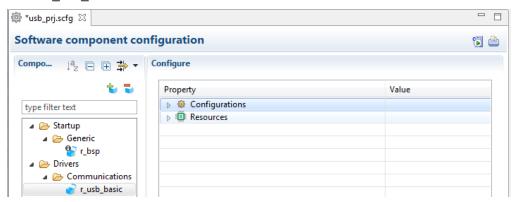


(2). Configuration Setting

r_bsp

Change the heap size when using DTC transfer. For the setting value, refer to the documentation for DTC FIT module.

b. r usb basic



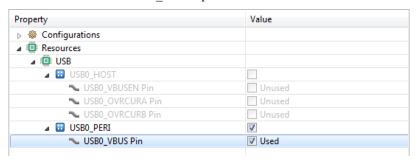
(a). Configurations

Set each item according to the user system.

For the detail of each item, refer to chapter "Configuration" in USB Basic Host and Peripheral Driver Firmware Integration Technology application note (Document number: R01AN2025).

(b). Resources

Check the check box for USBx_VBUS pin.

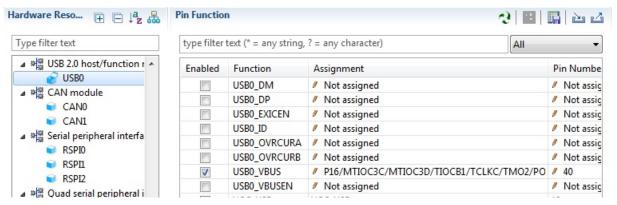


c. r_usb_pcdc

Refer to chapter "Configuration" in *USB Peripheral Communications Devices Class Driver (PCDC)* Firmware Integration Technology application note (Document number: R01AN2030).

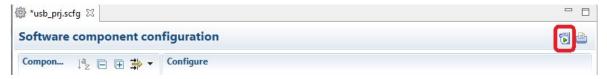
3. Pin Setting (Select "Pins" tab)

Select the port for USB pin match the user system.



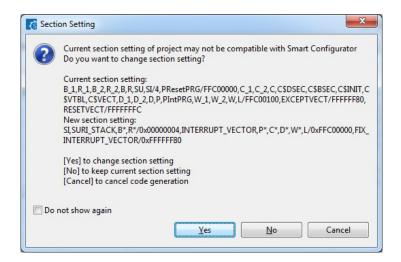
4. Generate Code

The Smart Configurator genrates source codes for USB FIT module and USB pin setting in "*ProjectDir*>*¥src¥smc gen*" folder by by clicking on the [(Generate Code)] button.



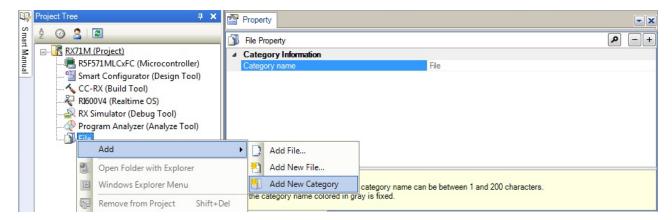
Note:

Select "Yes" if the following dialog box is displayed.



7.3 Add the application program and the configuration file

- 1. Copy the *demo src* folder in this package to the "<*ProjectDir*>¥src" folder.
- 2. Copy the RI600V4 configuration file (.cfg file) to "<ProjectDir>" folder.
- 3. Select "File" in the "Project Tree" and click the right button. Select [Add] → [Add New Category] and create the category to store the application program. Then select [Add File] and register the application program and the configuration file which are copied at the above 2.



Note:

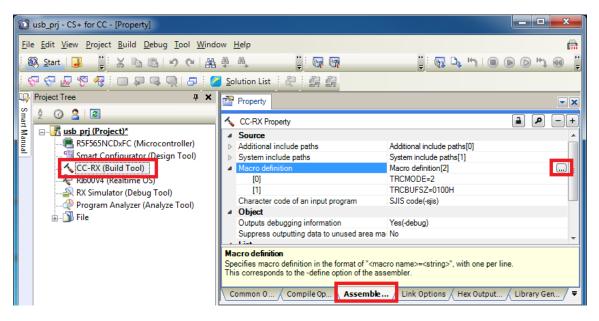
Remove the "task.c" file and "sample.cfg" created in "<*ProjectDir>*" folder by CS+.

7.4 Remote Macro Definition

Remove these macros since the following macros is defined in the new created project.

Select [CC-RX(Build Tool)] → [Assemble Options] tab, remove the following macros.

- 1. TRCMODE = 2
- 2. TRCBUFSZ = 0100H



7.5 Build Execution

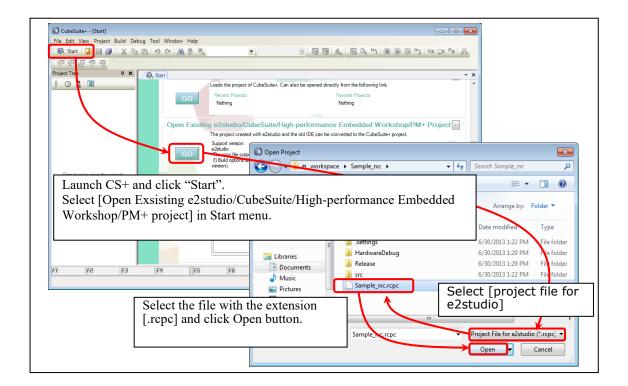
Excecute the build and generate the binary target program.

Using the e² studio project with CS+

The PCDC contains a project only for e² studio. When you use the PCDC with CS+, import the project to CS+ by following procedures.

[Note]

- Uncheck the checkbox Backup the project composition files after conversion in Project Convert Settings
- 2. The following method is not supported when using RI600V4. Refer to chapter 7, Using RI600V4 project with CS+.



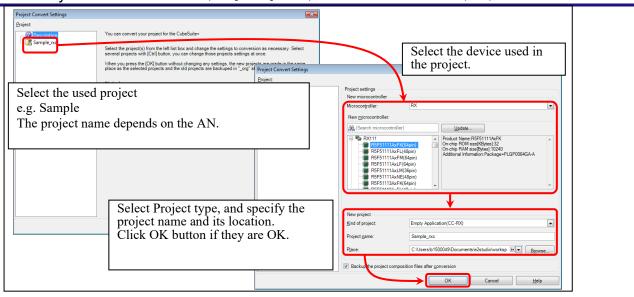


Figure 8-1 Using the e² studio project with CS+

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Revision Record

		Description	
Rev.	Date	Page	Summary
1.00	Oct 16, 2014	_	First Edition Issued.
1.10	Dec 26, 2014	_	RX71M is added in Target Device
1.11	Sep 30, 2015	_	RX63N/RX631 is added in Target Device.
1.20	Sep 30, 2016	_	 RX65N and RX651 are added in Target Device. Supporting DMA transfer. Supporting USB Host and Peripheral Interface Driver application note
1.21	Mar 31, 2017	_	The revision of USB Basic driver has been updated.
1.22	Sep 30, 2017	_	Supporting RX65N/RX651-2M
1.23	Mar 31, 2018	_	The revision of USB Basic driver has been updated.
1.24	Dec 28, 2018	_	Supported the real-time OS.
1.25	Apr 16, 2019	_	Added RX66T/RX72T in Target Device.
1.27	Jul 31, 2019	_	 RX72M is added in Target Device. RX63N is removed from Target Device.
1.30	Mar 1, 2020		 Supported the real time OS (uITRON:RI600V4). Added RX72N/RX66N in Target Device.
1.31	Mar 1, 2021	_	Added RX671 in Target Device.
1.40	Jun 30, 2022		Support Azure RTOS (USBX).

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The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

- 6. Voltage application waveform at input pin
 - Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).
- 7. Prohibition of access to reserved addresses
 - Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
- 8. Differences between products
 - Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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